

L Number	Hits	Search Text	DB	Time stamp
-	180	156/345.24.cccls.	USPAT; US-PGPUB	2003/11/23 17:17
-	16	156/345.24.cccls. and (lift\$3 with pin)	USPAT; US-PGPUB	2003/07/30 17:28
-	9	(h011021/\$.ipc. or c23c016/\$.ipc.) and ((detect near7 (wafer or substrate)) and lift\$4 and pin)	JPO; DERWENT	2003/11/19 18:25
-	15	(h011021/\$.ipc. or c23c016/\$.ipc.) and ((detector or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)	JPO; DERWENT	2003/07/30 17:44
-	29	(h011021/\$.ipc. or c23c016/\$.ipc.) and ((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)	JPO; DERWENT	2003/07/30 18:52
-	20	((h011021/\$.ipc. or c23c016/\$.ipc.) and ((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin) not ((h011021/\$.ipc. or c23c016/\$.ipc.) and ((detect near7 (wafer or substrate)) and lift\$4 and pin))	JPO; DERWENT	2003/07/30 17:45
-	83	(h011021/\$.ipc. or c23c016/\$.ipc.) and ((detect\$4 or sens\$3) near7 (wafer or substrate)) and (capacitive proximity)	JPO; DERWENT	2003/07/30 18:50
-	180	(h011021/\$.ipc. or c23c016/\$.ipc.) and ((detect\$4 or sens\$3) near7 (wafer or substrate)) and (capacitive near proximity)	JPO; DERWENT	2003/07/30 18:50
-	2	(h011021/\$.ipc. or c23c016/\$.ipc.) and ((detect\$4 or sens\$3) near7 (wafer or substrate)) and (capacitive near proximity))	JPO; DERWENT	2003/07/30 18:51
-	0	(118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)	JPO; DERWENT	2003/11/23 10:40
-	244	(118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)	USPAT; US-PGPUB	2003/07/30 18:54
-	40	(118/500).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)	USPAT; US-PGPUB	2003/07/30 18:54
-	136	(156/345.\$2).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)	USPAT; US-PGPUB	2003/07/30 18:54
-	310	((118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((118/500).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((156/345.\$2).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin))	USPAT; US-PGPUB	2003/07/30 18:55
-	25	((118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((118/500).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((156/345.\$2).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin))) and (capacitive near proximity)	USPAT; US-PGPUB	2003/11/23 11:03
-	1	6403933.pn.	USPAT; US-PGPUB	2003/08/05 16:38
-	1	6150638.pn.	USPAT; US-PGPUB	2003/08/05 17:00
-	1	6592673.pn.	USPAT; US-PGPUB	2003/08/05 18:41

	26	((118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate) and lift\$4 and pin)) or ((118/500).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((156/345.\$2).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin))) and (capacitive near proximity)	USPAT; US-PGPUB	2003/11/19 17:39
	7050	(h011021/\$.ipc. or c23c016/\$.ipc.) and (detect near7 (wafer or substrate)) and (detect near7 (wafer or substrate)) and (detect\$4 near2 (wafer or substrate))	JPO; DERWENT	2003/11/19 18:26
	6256	(h011021/\$.ipc. or c23c016/\$.ipc.) and (detect\$4 near2 (wafer or substrate))	JPO; DERWENT	2003/11/19 18:26
	3064	(h011021/\$.ipc. or c23c016/\$.ipc.) and (detect\$4 near (wafer or substrate))	JPO; DERWENT	2003/11/19 18:29
	10	(h011021/\$.ipc. or c23c016/\$.ipc.) and (detect\$4 near (wafer or substrate)) and (detect\$4 near (wafer or substrate)) and (pair near sensor)	JPO; DERWENT	2003/11/19 18:33
	0	(h011021/\$.ipc. or c23c016/\$.ipc.) and (detect near7 (wafer or substrate)) and (pair near (capacitive near proximity) near sensor)	JPO; DERWENT	2003/11/21 17:31
	0	(h011021/\$.ipc. or c23c016/\$.ipc.) and (detect near7 (wafer or substrate)) and (pair near capacitive near sensor)	JPO; DERWENT	2003/11/21 17:32
	5	(h011021/\$.ipc. or c23c016/\$.ipc.) and (detect near7 (wafer or substrate)) and (capacitive near sensor)	JPO; DERWENT	2003/11/21 17:40
	7	(h011021/\$.ipc. or c23c016/\$.ipc.) and (detect\$4 near7 (wafer or substrate)) and (capacitive near sensor)	JPO; DERWENT	2003/11/21 17:43
	66	(h011021/\$.ipc. or c23c016/\$.ipc.) and (detect\$4 near7 (wafer or substrate)) and (pair near7 sensor)	JPO; DERWENT	2003/11/23 11:57
	13	((118/715-733).cccls. or 118/500.cccls. or 156/345.\$2.cccls.) and (detect\$4 near7 (wafer or substrate)) and (pair near7 sensor)	USPAT; US-PGPUB	2003/11/23 10:59
	997	(detect\$4 near7 (wafer or substrate)) and (pair near7 sensor)	USPAT; US-PGPUB	2003/11/23 11:50
	26	((118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((118/500).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((156/345.\$2).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin))) and (capacit\$4 near proximity)	USPAT; US-PGPUB	2003/11/23 11:02
	34	((118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((118/500).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((156/345.\$2).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin))) and (capacit\$4 near7 proximity)	USPAT; US-PGPUB	2003/11/23 11:02
	26	((118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((118/500).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((156/345.\$2).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin))) and (capacitive near proximity)	USPAT; US-PGPUB	2003/11/23 11:03

		8	((((118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((118/500).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((156/345.\$2).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) and (capacit\$4 near7 proximity)) not (((118/715-733).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((118/500).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin)) or ((156/345.\$2).cccls. and (((detect\$4 or sens\$3) near7 (wafer or substrate)) and lift\$4 and pin))) and (capacitive near proximity))	USPAT; US-PGPUB	2003/11/23 11:03
		4	(detect\$4 near7 (wafer or substrate)) and (pair near7 sensor) and (capacit\$4 near proximity)	USPAT; US-PGPUB	2003/11/23 11:50
		251	(detect\$4 near7 (wafer or substrate)) and (pair near sensor)	USPAT;	2003/11/23
		228	(detect\$4 near7 (wafer or substrate)) and (pair near sensor) and (logic or control\$4)	USPAT; US-PGPUB	2003/11/23 11:50
		212	((detect\$4 near7 (wafer or substrate)) and (pair near sensor) and (logic or control\$4)) and @ad<20020221	USPAT; US-PGPUB	2003/11/23 11:52
		1	5166679.pn.	USPAT;	2003/11/23
		19	(capacit\$4 near proximity near sens\$4) and electrode and pin	USPAT; US-PGPUB	2003/11/23 12:57
		1	4990459.pn.	USPAT; US-PGPUB	2003/11/23 12:59
				USPAT; US-PGPUB	2003/11/23 17:17